

Title (en)

COOLING DEVICE FOR A PRINTED CIRCUIT BOARD

Title (de)

KÜHLVORRICHTUNG FÜR EINE LEITERPLATTE

Title (fr)

DISPOSITIF DE REFROIDISSEMENT POUR CARTE DE CIRCUIT IMPRIME

Publication

**EP 2936955 A1 20151028 (FR)**

Application

**EP 13805864 A 20131213**

Priority

- FR 1262300 A 20121219
- EP 2013076501 W 20131213

Abstract (en)

[origin: WO2014095610A1] The invention relates to a cooling device for a printed circuit board, comprising a printed circuit board equipped with at least one face or first face and at least one heat sink (9) brazed to said at least one face of the printed circuit, in which said at least one heat sink (9) can be disposed in a flow of coolant. The invention is suitable for motor vehicles.

IPC 8 full level

**H05K 7/20** (2006.01)

CPC (source: EP US)

**H05K 1/0206** (2013.01 - EP US); **H05K 1/115** (2013.01 - US); **H05K 1/181** (2013.01 - US); **H05K 7/20163** (2013.01 - EP US); **H05K 7/205** (2013.01 - EP US); **H05K 7/20854** (2013.01 - EP US); **H05K 7/20863** (2013.01 - US); **H05K 2201/066** (2013.01 - EP US); **H05K 2201/09545** (2013.01 - EP US)

Citation (search report)

See references of WO 2014095610A1

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

DOCDB simple family (publication)

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DOCDB simple family (application)

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